Communications & PR Review

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SOLDERING ON

As global chip demand surges, India's design-led startups seek funds, mentorship, and infrastructure to stay in the race By Rohit Chintapalli

DIGITIMES asia

India's IESA targets global ties, skills push for chip growth

Ashok Chandak, President, IESA and SEMI India. Credit: IESA

FORTUNE

mint

HCL-Foxconn display chip unit gets govt nod

₹3,700 cr project India's first display chip testing & manufacturing facility

Chronicle

India to drop tariffs on US imports, says Trump

US President does not want Apple to set up its plants in India

mint

HCL-Foxconn display chip unit gets govt nod

₹3,700 cr project India's first display chip testing & manufacturing facility

THE HINDU

Cabinet approves ₹3,700 crore display chip-making unit in U.P.

The Hindu Bureau
NEW DELHI

The Union Cabinet on Wednesday approved a display driver chip manufacturing unit in Jewar, Uttar Pradesh, Minister of Electronics and Information Technology Ashwini Vaishnaw announced.

The unit, which will attract investments worth ₹3,700 crore according to a government statement, will be a joint venture by Indian firm HCL and Taiwanese electronics manufacturing giant Foxconn.

This semiconductor unit is the sixth to be supported under the ₹76,000 crore first phase of the India Semiconductor Mission (ISM). The unit will churn out 36 million chips a month from 20,000 wafers, Mr. Vaishnaw said.

"What we understand is that once this unit is there, the display panel plant will also come to India," Mr. Vaishnaw said. "This will more or less meet about 40% of India's capacity." Chips from this unit will go into laptops, PCs, phones and automobiles.

Display panel plant will also come to India, says Vaishnaw.

First chip plant

This is the first semiconductor plant in Uttar Pradesh, Mr. Vaishnaw said adding firms choose the States and build units themselves, calling Jewar an "up and coming industrial area".

The unit addresses "a critical gap in India's display and electronics value chain," said Ashok Chandak, president of the India Electronics and Semiconductor Association.

Business Remedies

HCL-Foxconn plant reflects India's growing maturity in semiconductor manufacturing

IANS
New Delhi

Business Remedies. The Cabinet's approval of the HCL-Foxconn chip plant reflects India's growing maturity in semiconductor manufacturing, with trusted partners, strategic intent and industrial scale, industry experts said.

The Cabinet, chaired by Prime Minister Narendra Modi, has approved the establishment of the semiconductor unit in Uttar Pradesh under the India Semiconductor Mission (ISM) that would attract investment of Rs. 3,700 crore.

This marks a strategic milestone in India's semiconductor journey, said experts.

"With an investment of Rs. 3,700 crore, the project brings large scale advanced packaging and testing capabilities specifically for display driver ICs, addressing a critical gap in India's display and electronics value chain," said **Ashok Chandak**, President IESA and SEMI India.

Foxconn, one of the world's largest electronics manufacturers, brings world-class expertise in chip packaging and testing core to the downstream semiconductor supply chains.

HCL Group, with its robust technology services, engineering strength, and global relationships, adds local execution capability and talent access.

"Together, this joint venture lays the foundation for India to emerge as a preferred global hub for semiconductor OSAT (Outsourced Semiconductor Assembly and Test) operations -aligning with the vision of 'Make in India' and 'Make for the World' with great support from the Centre and states," Chandak said.

The plant near Jewar airport is designed for 20,000 wafers per month. The design output capacity is 36 million units per month. It will manufacture display driver chips for mobile phones, laptops, automobiles, PCs, and other devices that have display.

"This project can become landmark as it can create major value addition in India's electronics manufacturing for mobiles, laptops, consumer and automotive, etc," Chandak noted. Five semiconductor units are in advanced stages of construction. With this sixth unit, "Bharat moves forward in its journey to develop the strategically vital semiconductor industry," according to the Cabinet.

BIZZ BUZZ

India coming of age in semicon space

The Telegraph

Foxconn, HCL team up for chip unit

IANS
Wire Service

New Delhi, May 14 (IANS) The Cabinet's approval of the HCL-Foxconn chip plant reflects India's growing maturity in semiconductor manufacturing -- with trusted partners, strategic intent and industrial scale, industry experts said on Wednesday.

The Cabinet, chaired by Prime Minister Narendra Modi, has approved the establishment of the semiconductor unit in Uttar Pradesh under the India Semiconductor Mission (ISM) that would attract investment of Rs 3,700 crore.

This marks a strategic milestone in India's semiconductor journey, said experts.

"With an investment of Rs 3,700 crore, the project brings large scale advanced packaging and testing capabilities specifically for display driver ICs -- addressing a critical gap in India's display and electronics value chain," said Ashok Chandak, President IESA and SEMI India.

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THE HINDU

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businessline.

Cabinet Approval of HCL-Foxconn JV a Fillip for Semicon Manufacturing in India

India's semiconductor market is expected to grow from USD 52 billion in 2024 to USD 103.4 billion by 2030, according to a report by the India Electronics and Semiconductor Association (IESA).

The Union Cabinet's approval of the INR 3706-crore HCL-Foxconn outsourced semiconductor assembly and test (OSAT) facility under the India Semiconductor Mission is a major fillip for the semiconductor manufacturing industry in India.

The government said that already five semiconductor units are in advanced stages of construction in the country. With this sixth unit, Bharat moves forward in its journey to develop the strategically vital semiconductor industry, Union Minister Ashwini Vaishnaw said during the announcement.

The proposed unit will be located near the upcoming Jewar airport, within the Yamuna Expressway Industrial Development Authority (YEIDA) region. The facility will produce display driver chips for mobile phones, laptops, automobiles, PCs, and various other display-equipped devices. It is designed to handle 20,000 wafers every month, with an output capacity of 36 million units per month.

Entrepreneur
2025

binet clears semiconductor unit for Uttar Pradesh

HIGHLIGHTS

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IANS
Wire Service

THE HINDU

'Trump rhetoric won't harm Apple's India manufacturing'

There is no alarm over the U.S. President's remarks "we don't want you building in India" to CEO Tim Cook, as manufacturing commitments for India and the U.S. are different, say officials here

INFO-TECH

Cabinet approves ₹3,700-crore HCL-Foxconn semiconductor unit in UP

**The semiconductor plant will be set up near Jewar airport in t
Yamuna Expressway Industrial Development Authority (YEIDA
Uttar Pradesh**

By BL Bengaluru Bureau

The Union Cabinet, led by Prime Minister Modi, has approved the setting up of a semiconductor unit under the India Semiconductor Mission. The unit, a joint venture between HCL and Foxconn, is expected to attract an investment of ₹3,700 crore.

The two companies will set up the plant near Jewar airport in the Yamuna Expressway Industrial Development Authority (YEIDA) in Uttar Pradesh.

FINANCIAL EXPRESS

HCL-Foxconn in OSAT joint venture

With an investment of ₹3,700 crore, the project brings large scale advanced packaging and testing capabilities specifically for display driver ICs

The Cabinet's approval of the HCL-Foxconn OSAT joint venture marks a strategic milestone in India's semiconductor journey.

"With an investment of ₹3,700 crore, the project brings large scale advanced packaging and testing capabilities specifically for display driver ICs—addressing a critical gap in India's display and electronics value chain. This isn't just about building infrastructure—it reflects India's growing maturity in semiconductor manufacturing, with trusted partners, strategic intent, and industrial scale," commented Ashok Chandak, President IESA and SEMI India.

Foxconn, one of the world's largest electronics manufacturers, brings world-class expertise in chip packaging and testing—core to the downstream semiconductor supply chain. HCL Group, with its robust technology services, engineering strength, and global relationships, adds local execution capability and talent access.

"Together, this joint venture lays the foundation for India to emerge as a preferred global hub for semiconductor OSAT operations—truly aligning with the vision of 'Make in India, Make for the World' with great support from center and states and This project can become landmark as it can create major value addition in India's electronics manufacturing for mobiles, laptops, consumer, automotive, etc," he added.

Hans India

HCL-Foxconn plant reflects India's growing maturity in semiconductor manufacturing

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-- IANS

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6,089 Impressions	3,983 Engagements	65.41% Engagement rate
3,825 Clicks	62.82% Click-through rate	152 Reactions
1 Comment	5 Reposts	

Post performance

6,011 Impressions	484 Engagements	8.05% Engagement rate
331 Clicks	5.51% Click-through rate	151 Reactions
2 Comments	0 Reposts	

Post performance

4,530 Impressions	216 Engagements	4.77% Engagement rate
115 Clicks	2.54% Click-through rate	94 Reactions
1 Comment	6 Reposts	

Post performance

4,254 Impressions	226 Engagements	5.31% Engagement rate
114 Clicks	2.68% Click-through rate	104 Reactions
5 Comments	3 Reposts	

Post performance

3,331 Impressions	275 Engagements	8.26% Engagement rate
185 Clicks	5.55% Click-through rate	80 Reactions
4 Comments	6 Reposts	